Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	1	10/736395	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/11/28 10:31
L3	1	("6383928").PN.	US-PGPUB; USPAT	OR	OFF	2005/11/28 10:46
L4	3671	bias near5 sputter\$4	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/28 10:47
L5	0	3 and 4	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/28 10:47
L6	1075188	interconnect\$4	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/28 10:47
L7	1628136	copper or cu	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR ,	ON	2005/11/28 10:47
L8	636	6 and 7 and 4	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/28 10:48
L9	405911	inhibitor or (native adj1 oxide) or (copper adj1 oxide)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/28 10:48
L10	87	8 and 9	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/28 11:14

L17	1	1 and inhibitor	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/28 12:34
L18	1	"6287977".pn. and electroplat\$4	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/28 12:53
L19	1	1 and electroplat\$4	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR .	ON	2005/11/28 12:34
L20	86	10 and (al or aluminum)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/28 12:47
L21	1	18 and (al or aluminum)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/28 12:47
L22	2	"6287977".pn. and dielectric	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/28 13:24
L23	2	"6350687".pn.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/28 13:30
L24	479	inhibit\$4 with (cuo or (copper adj1 oxide) or ((nature or native) adj1 oxide))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/28 13:33

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L25	65	24 and sputter\$4	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/28 13:49
L26	0	vapor\$8 with inhibitor with (cu or copper) with ((copper adj1 oxide) or cuo)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/28 13:52
L27	21	vapor\$8 same inhibitor same (cu or copper) same ((copper adj1 oxide) or cuo)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/28 14:02
L28	634238	tan or ta or (tantalum)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/28 14:03
L29	383	((plasma near3 chemical) or Pecvd) with 28	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/28 14:04
L30	303	semiconductor and 29	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/28 14:08
L31	1	1 and deposit\$4	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/28 14:45
L32	6	(("20040152301") or ("20020115287") or ("20020028576") or ("6709987") or ("6559061") or ("6287977")).PN.	US-PGPUB; USPAT	OR	OFF	2005/11/28 14:47
L33	6	32 and vapor\$4	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/11/28 14:47